

TIGER ASIC for GEM Readout

Streaming Readout VI
May 13-15, 2020



Istituto Nazionale di Fisica Nucleare

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The BESIII GEM project has been funded by European Commission within the calls H2020-
MSCA-RISE-2014 and FEST RISE-MSCA-H2020-2020

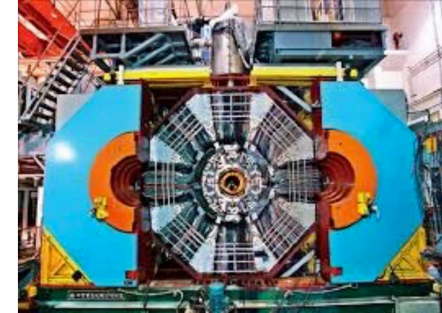
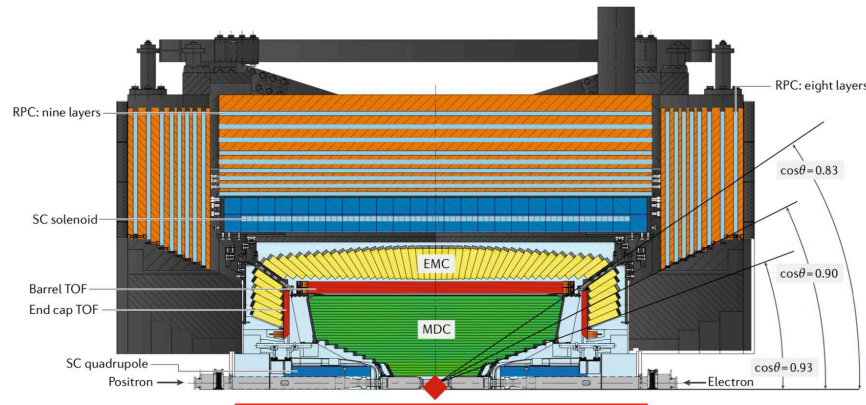


The BESIII Experiment at BEPCII

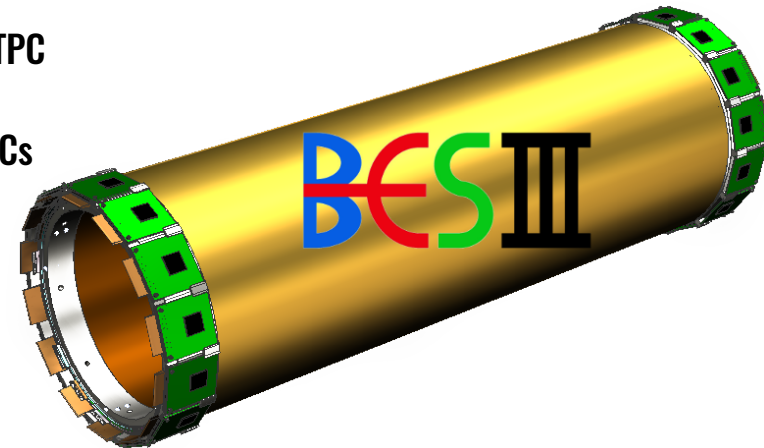
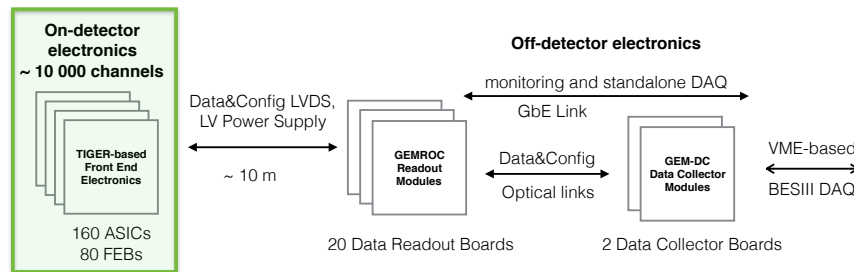


- ▶ The BESIII experiment @ BEPCII (Beijing Electron-Positron Collider) - operation since 1989, upgrade to BEPCII in 2008
- ▶ BESIII Collaboration counts ~500 authors from 67 Institutions, 14 Countries

Parameters	BEPCII
Center of mass Energy	$(2.0 \div 4.6) \text{ GeV}$
Peak luminosity at $2 \times 1.89 \text{ GeV}$	$\sim 10^{33} \text{ cm}^{-2} \text{ s}^{-1}$
Circumference	237.5 m
Number of rings	2
RF frequency	499.8 MHz
Number of bunches	2×93
Beam current	$2 \times 0.91 \text{ A}$
Bunch spacing	$2.4/8 \text{ m ns}^{-1}$
Bunch length (σ_z)	1.5 cm
Bunch width (σ_x)	$\sim 380 \mu\text{m}$
Bunch height (σ_y)	$\sim 5.7 \mu\text{m}$



- new lightweight tracker based on an innovative Cylindrical Gas Electron Multiplier (CGEM) detector for the upgrade of the BESIII spectrometer
- analogue readout of the CGEM enables the use of charge centroid and μ -TPC algorithms to improve the spatial resolution
- 10 000 channels are readout by 160 dedicated 64-channel front-end ASICs



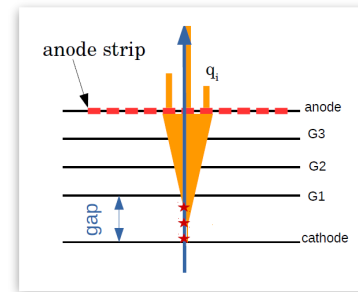
Upgrade of the BESIII Inner Tracker



- Spatial resolution: $\sigma_{xy} = 130 \mu\text{m}$, $\sigma_z = 300 \mu\text{m}$
- Momentum resolution: $\sigma_{pt}/p_t = 0.5\% @ 1 \text{ GeV}/c$
- Efficiency = 98%
- Material budget $\leq 1.5\%$ of X_0 for all layers
- Rate capability: $\sim 10^4 \text{ Hz}/\text{cm}^2$
- Coverage: 93% 4π

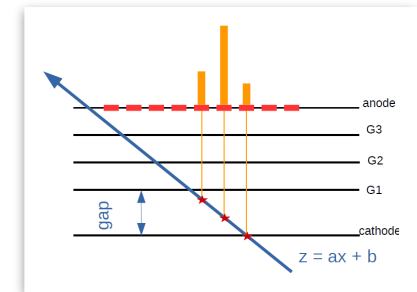
Reconstruction algorithms

Charge Centroid (CC)

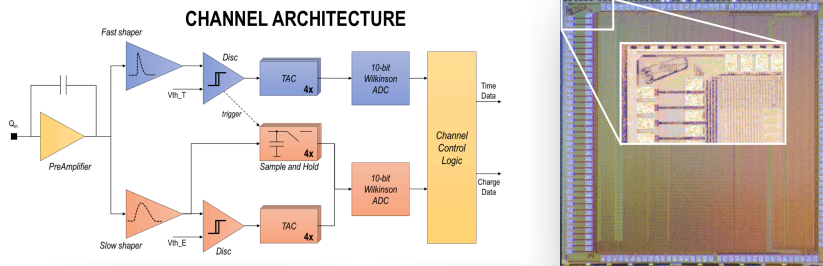


Weighted average of strip positions by collected charge

μ -TPC readout



2D track reconstruction exploiting time of arrival and drift velocity



TIGER ASIC for the CGEM-IT Readout

- provides an analogue readout (time and charge information) for CC and μ -TPC algorithms
- 64-channel Application Specific Integrated Circuit



TIGER ASIC for the BESIII CGEM-IT



- TIGER has been designed for the readout of the CGEM-IT (Cylindrical Gas Electron Multiplier Inner Tracker)
 - new inner tracker of BESIII Experiment
 - 10 000 channels readout by 160 64-channel TIGER ASICs
- Time and charge measurements with fully-digital output
 - Charge centroid and μ -TPC algorithms
 - 130 μm spatial resolution with strip pitch of 650 μm
- Sensor capacitance dependent on strips length, up to 100 pF
- Input charge: 2 - 50 fC
- Time resolution for μ TPC mode: 5 ns
- Rate per channel: 60 kHz (4x safety factor)
- Power consumption: < 12 mW/ch
- SEU-tolerant

Efficiency	98%
Rate capability	10 kHz/cm ²
$\sigma_{r\phi}$	130 μm
σ_z	300 μm
σ_{pt}/p_t	0.5% at 1 GeV/c
Coverage	93% 4 π
Material budget	< 1.5 X_0
Inner radius	78 mm
Outer radius	178 mm
Magnetic field	1 T

Channel Architecture

- **Analogue Front-End:**

- Charge Sensitive Amplifier
- dual-branch shaper optimized for time and charge measurements

- **Trigger-less readout architecture:**

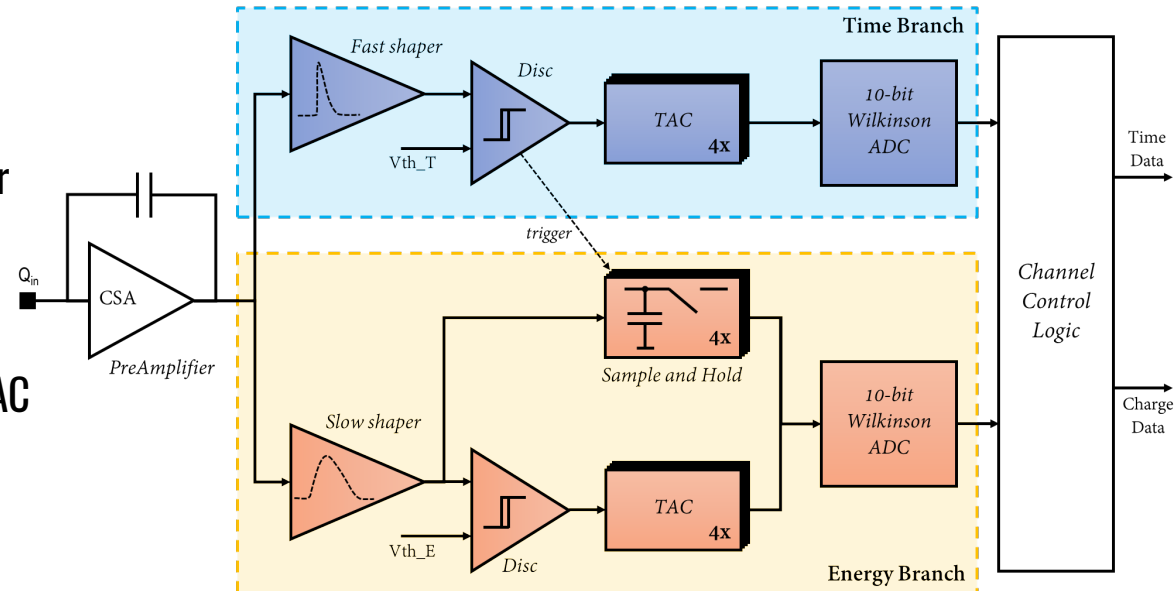
- 2 LE discriminators with 6-bit DAC for threshold equalization
- dual-threshold readout mode

- **Timestamp on rising edge of fast branch**

- Time resolution < 5 ns
- Low-power TDCs based on analogue interpolation

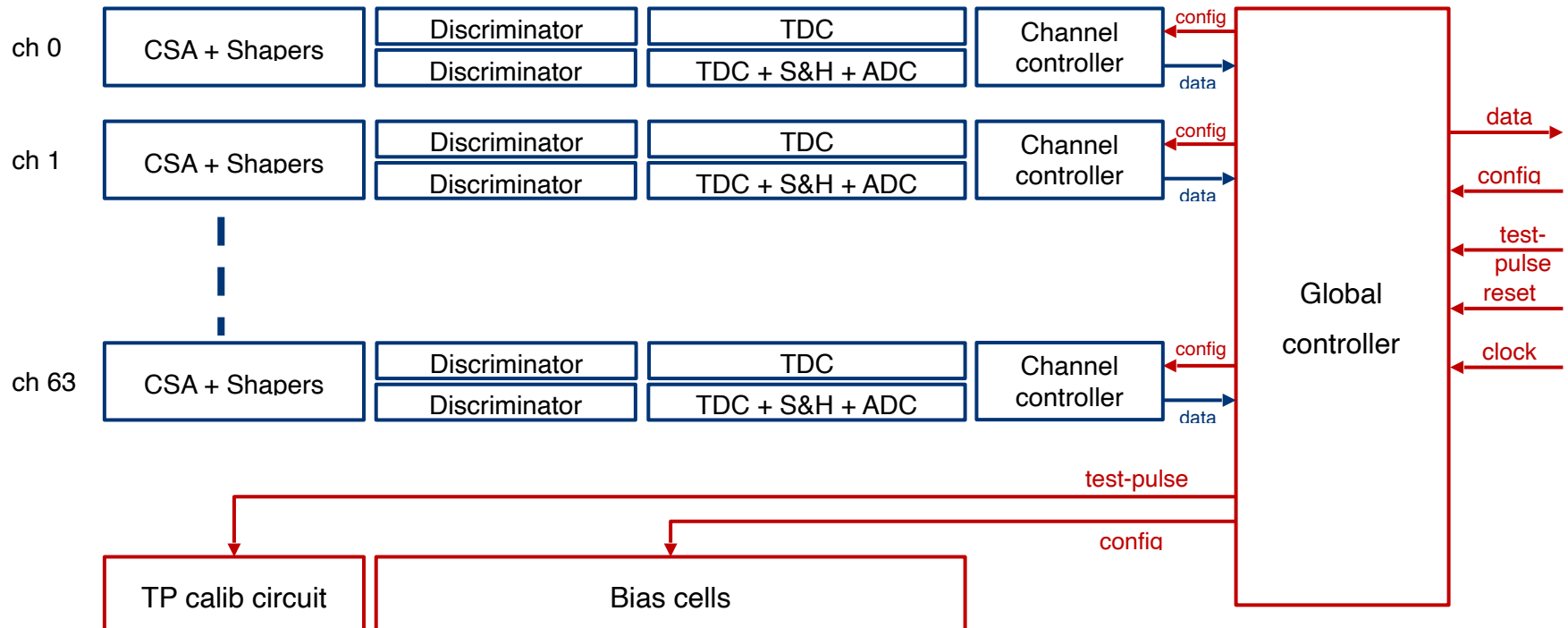
- **Charge measurement:**

- ToT: timestamp on rising/falling edge
- S/H: slow shaper output sampled and digitized with a 10-bit Wilkinson ADC



ASIC Architecture

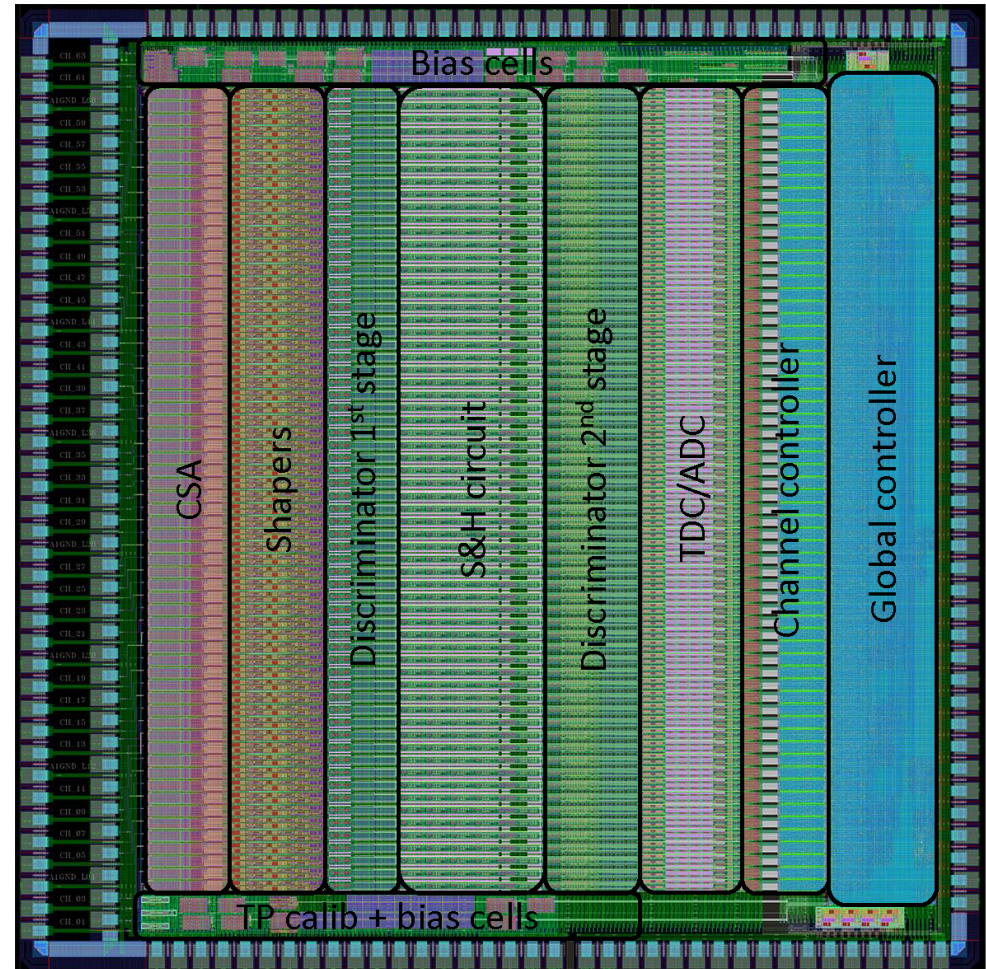
- The ASIC embeds an array of 64 channels (amplifier, discriminator, TDC/ADC), a digital global controller, bias and references generators and a test-pulse calibration circuit.



Chip Floorplan



- 5 x 5 mm² 110nm CMOS technology
- Digital backend adapted from **TOFPET2*** (SEU protected)
- **64 channels**: CSA, shapers, TDC/ADC, local controller
- On-chip bias and power management
- On-chip calibration circuitry
- **Trigger-less** operation, fully digital output
- 160-200 MHz system clock
- 4 TX SDR/DDR LVDS links, 8B/10B encoding
- 10 MHz SPI-like configuration link
- Power consumption < **12 mW/ch**
- Sustained event rate > **100 kHz/ch**

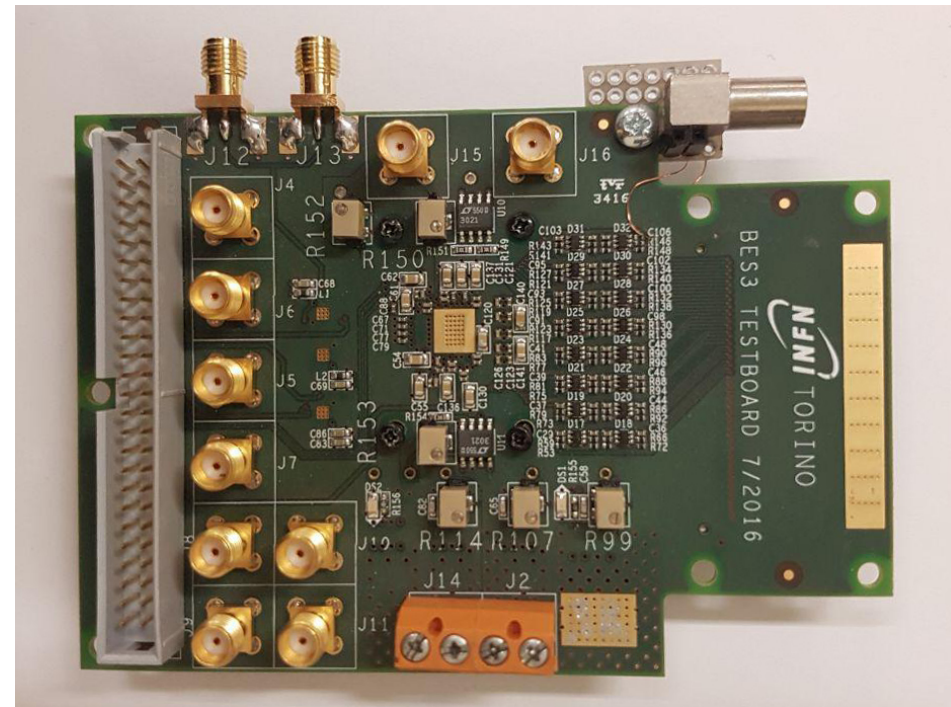


Chip Test Board



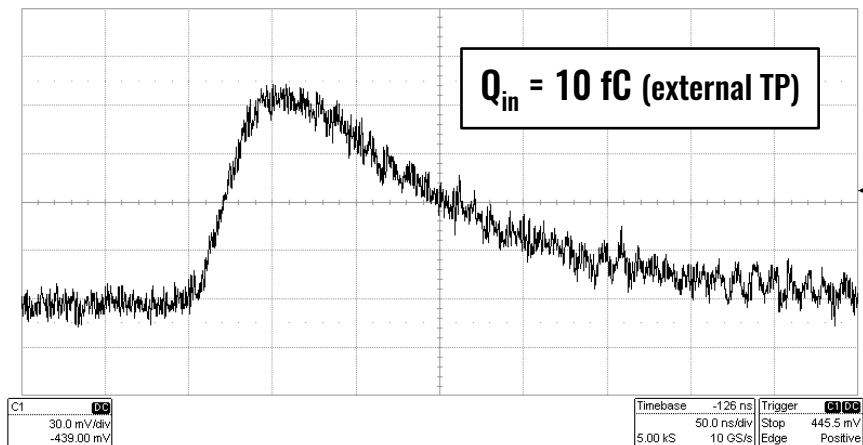
Test-board for ASIC electrical characterization

- Trimming capability for analogue and digital power domains and external reference voltages
- Debug IO ports:
 2. External test-pulse injection
 3. External capacitor insertion
 4. T-branch shaper output and threshold probe points (ch. 63)
 5. Digital back-end control signals (TDC and S&H)



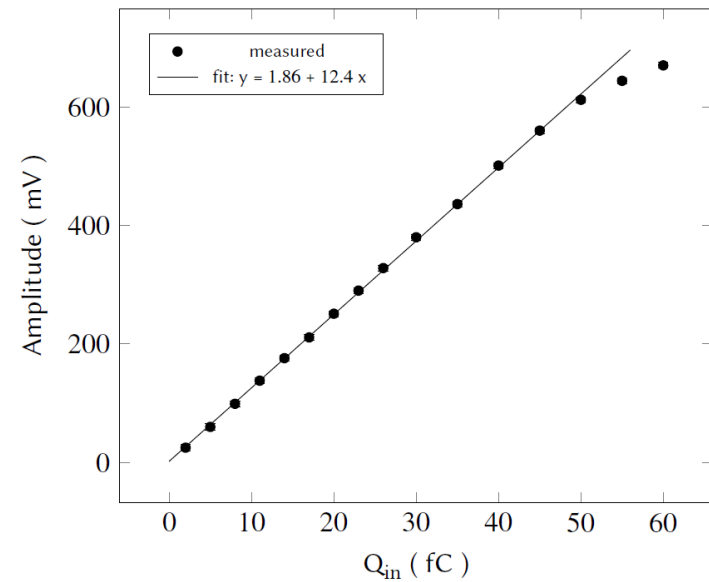
Electrical Characterization

Front-end response and linearity



$\Delta V \approx 120 \text{ mV}$

Peaking time $\approx 60 \text{ ns}$



Gain $\approx 12.4 \text{ mV/fC}$

Electrical Characterization

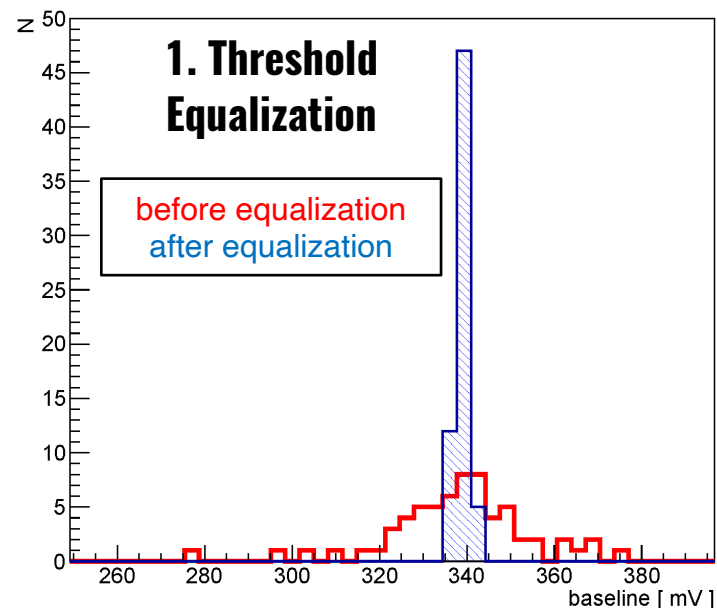
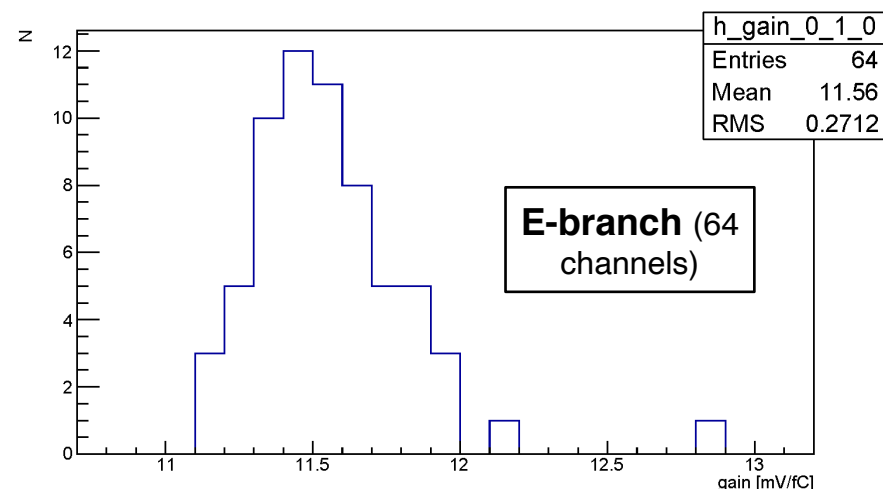
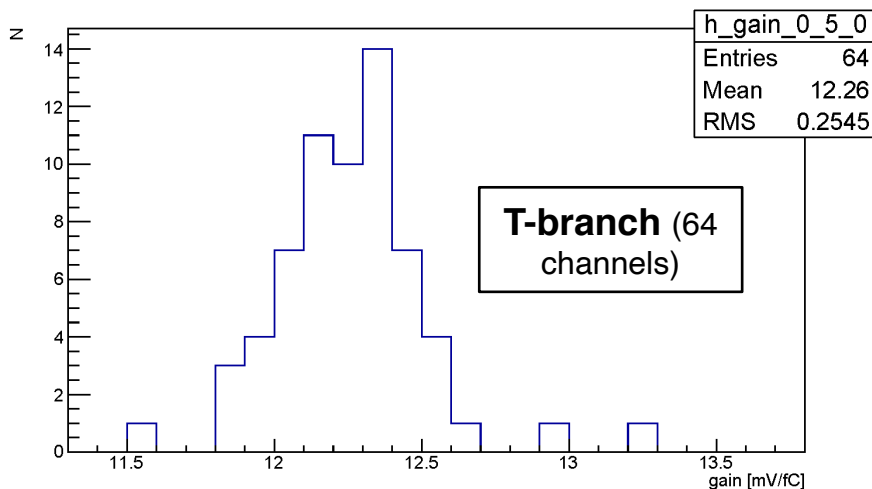
Threshold scan and gain dispersion

1. V_{th} scan to generate LUT and equalize thresholds

➤ below 5 mV RMS dispersion after V_{th} equalization

2. V_{th} scan with internal TP to measure gain of 64 channels on both branches

2. Gain dispersion

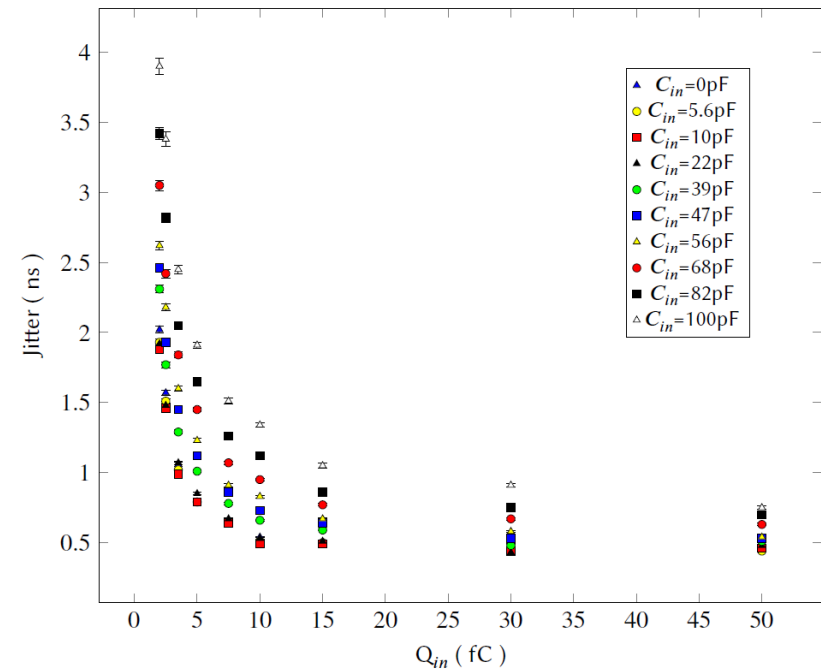
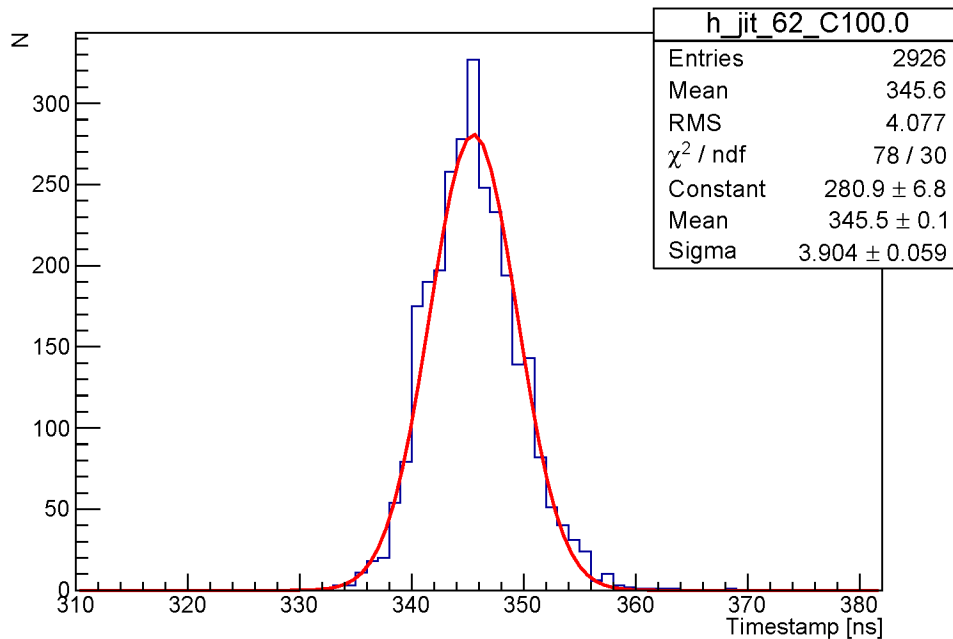


Electrical Characterization

Timing Resolution

- TP injected to VFE, generated by on-chip calibration circuit
- Here, fixed amplitude and time skew in respect to system clock

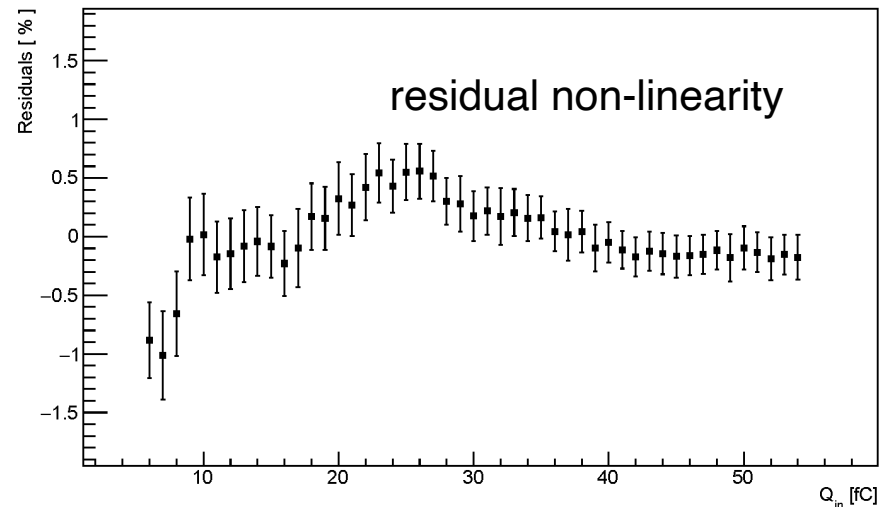
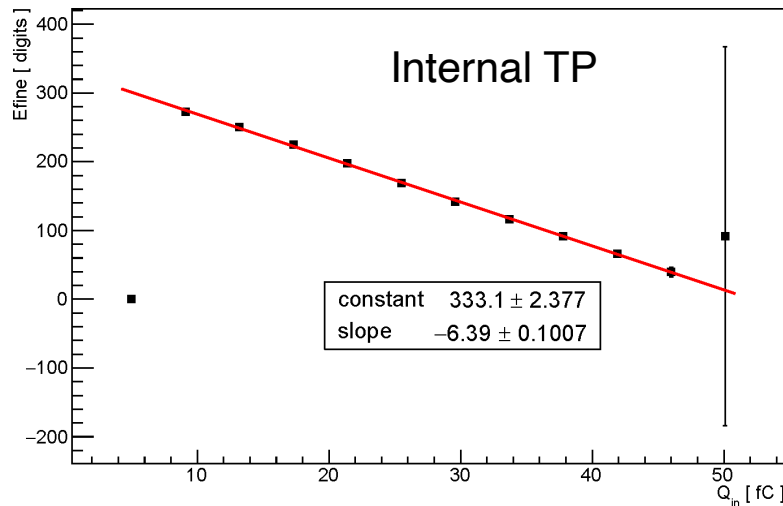
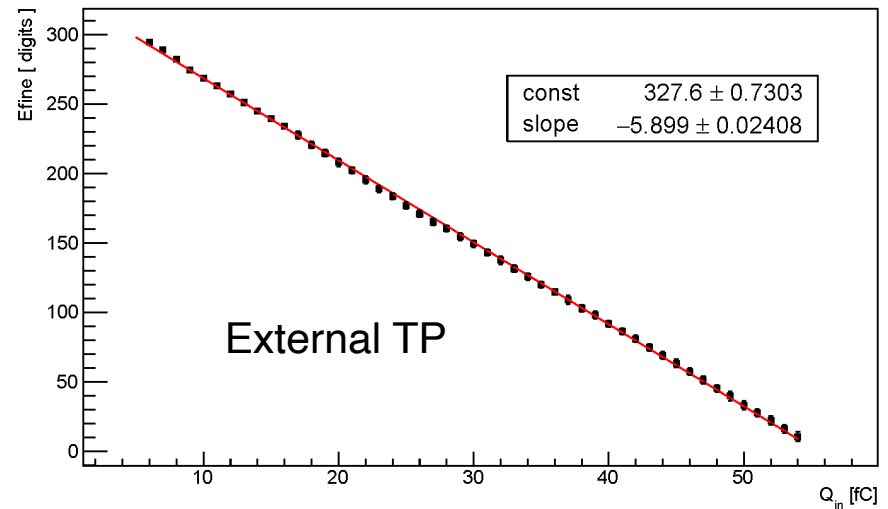
- Jitter vs. Q_{in} vs. C_{in}



Electrical Characterization

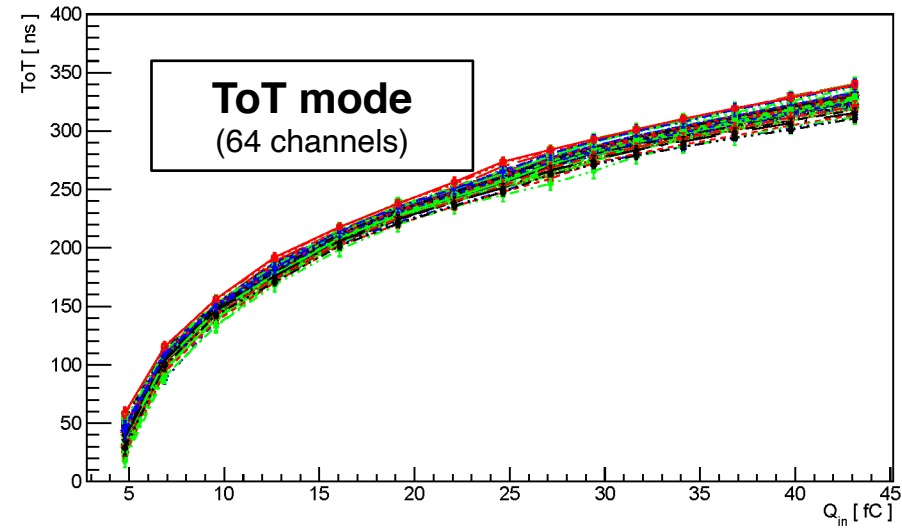
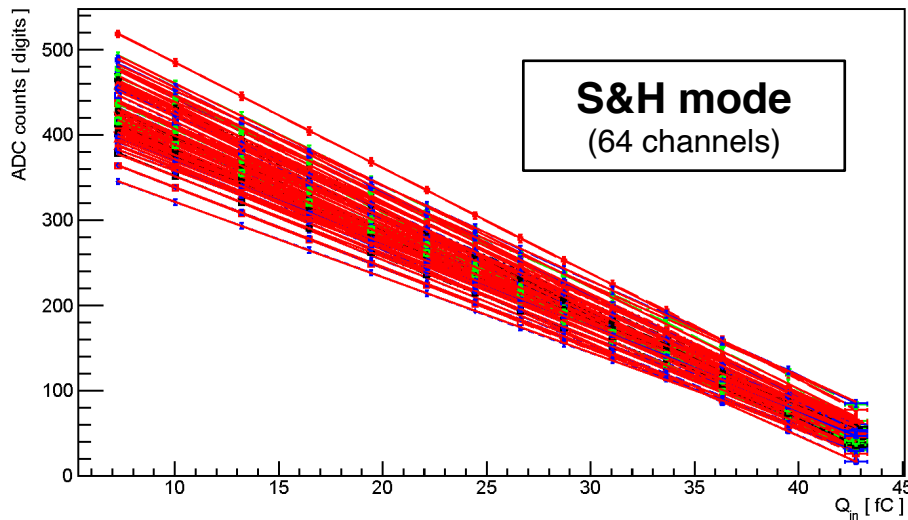
Charge Measurement

- **S/H dynamic range and linearity** with external test-pulse generator (ch. 63 input debug port)
- **Back-annotation for internal test pulse calibration** to assess all channels



Electrical Characterization

Charge Measurement

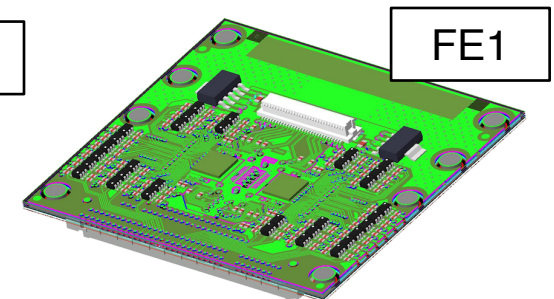
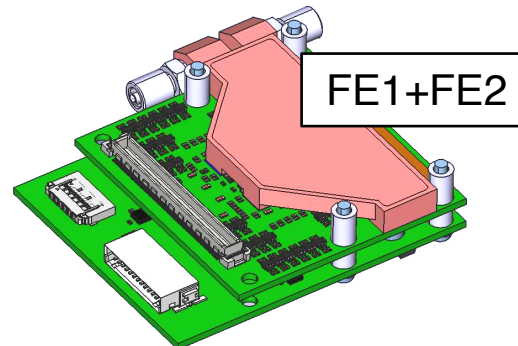
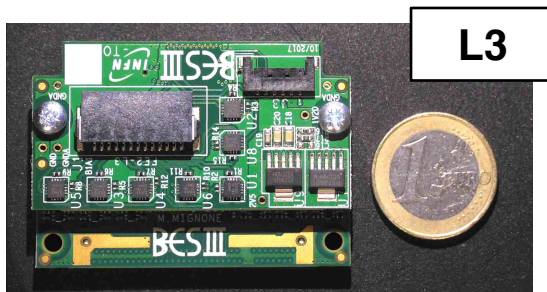
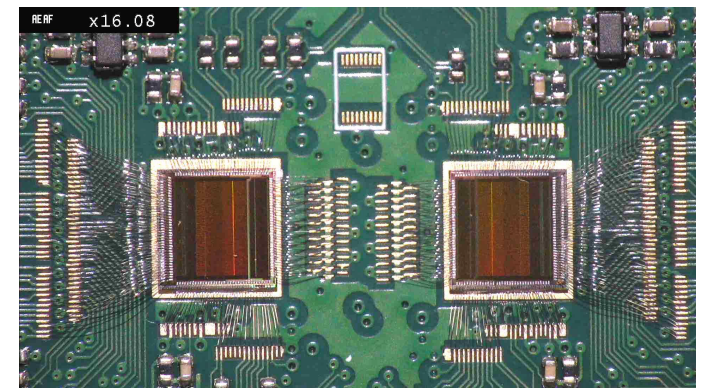
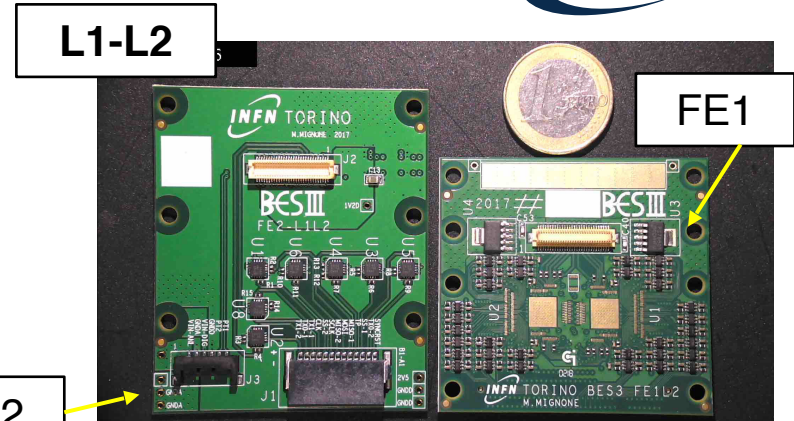


- **Linear response** from S&H circuit - easy to calibrate
- S&H limited by **saturation** of FE and ADC above 50 fC
- ToT response intrinsically not linear with CR-RC shapers
- **ToT provides** moderate energy resolution at low Q_{in} , allows for **extended dynamic range**

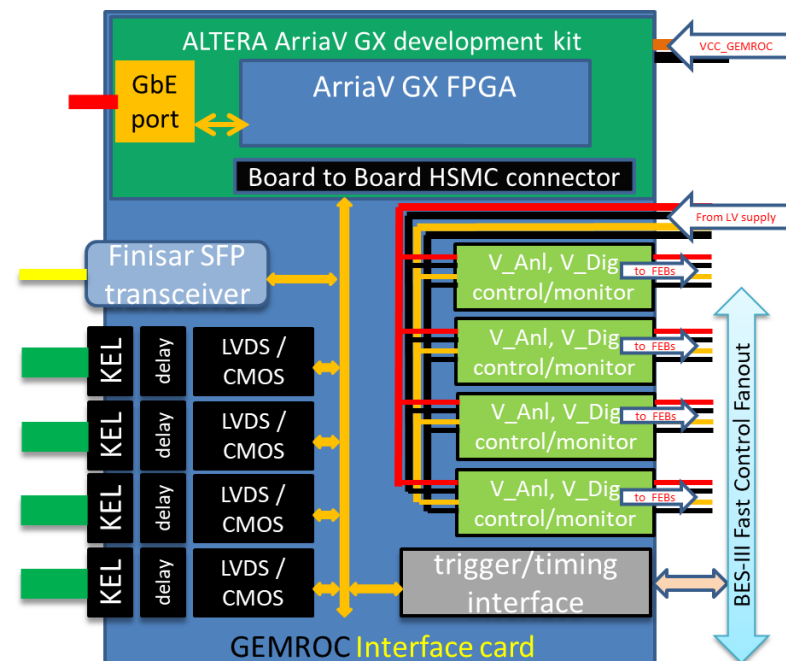
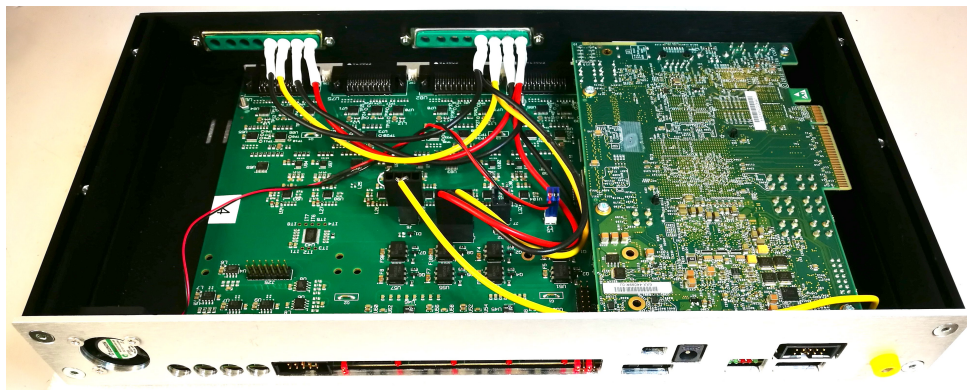
FEB (Front-End Board)

Front-End Board (FEB) for the on-detector CGEM electronics

- Stack of two printed circuit boards:
 - FE1: analogue-most layer
 - FE2: digital layer
- 2 TIGER ASICs mounted on FE1 (128 channels per FEB)
- Water-cooling heat exchanger plate for operation at controlled temperature
- Different layout and routing for L3 FEBs due to space constraints inside BESIII



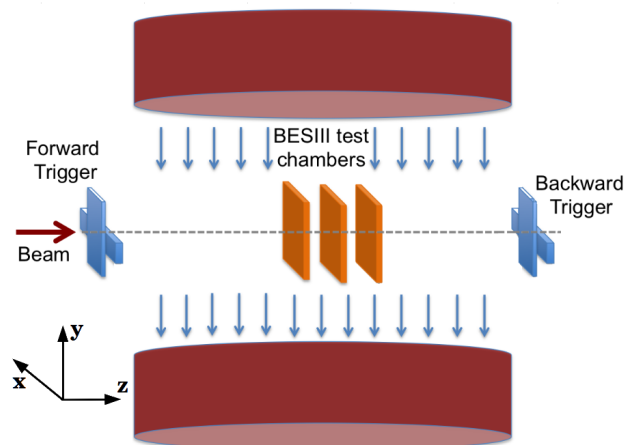
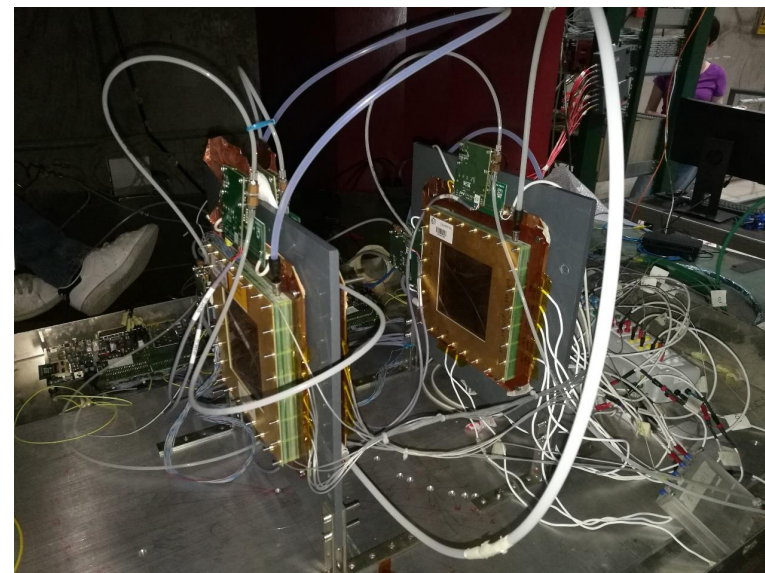
GEMROC (GEM ReadOut Card)



- Developed by INFN Ferrara
- Off-detector electronics for the readout of the CGEM-IT detector (160 TIGER)
- Provides power, configuration and data interface to the TIGER ASICs (up to 8 TIGER for each GEMROC)
- **Trigger-Matching** operations (trigger-less mode also available)

Beam tests with planar GEMs

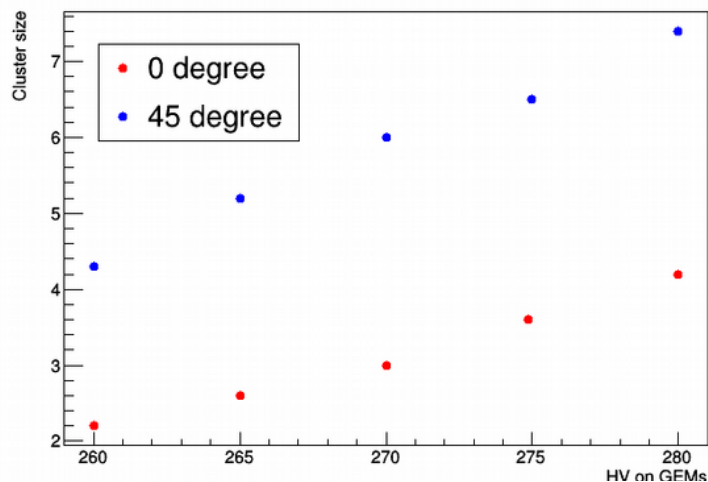
- 2 beam tests to validate the ASIC with the sensor:
 - 10 x 10 cm² planar GEMs
 - XY orthogonal strips
 - Turin FPGA-based DAQ -> readout of 8 TIGER
- Nov 2017: Mainz Microtron (TIGER prototype version)
- Apr 2018: CERN H4 beam line (TIGER final version)



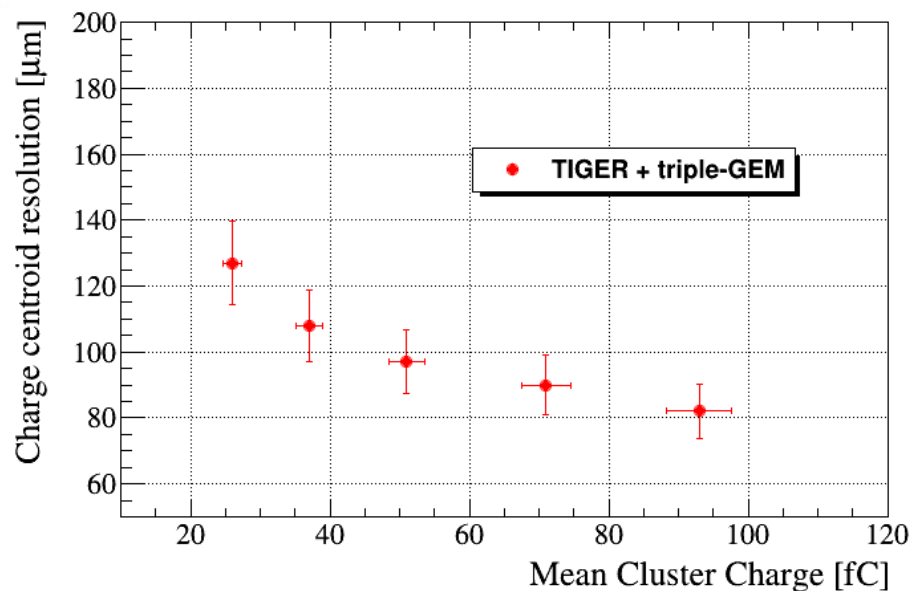
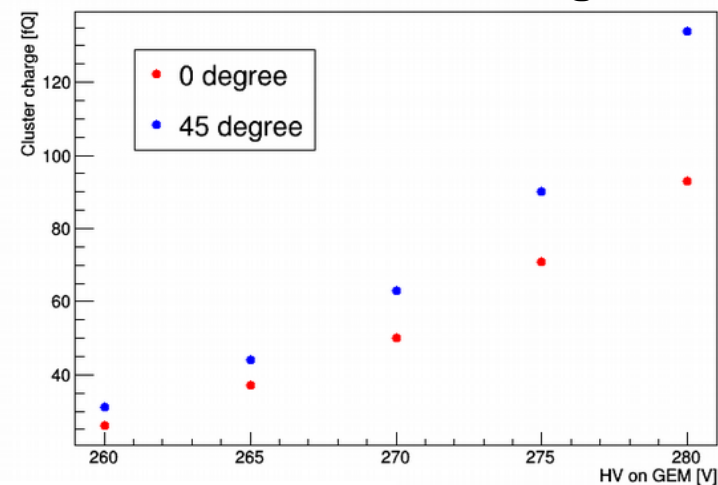
Trigger-less readout: trigger from scintillator bars injected as a digital test-pulse on one TIGER channel to be used as a reference for offline trigger-matching

Beam tests with planar GEMs

Event Cluster size



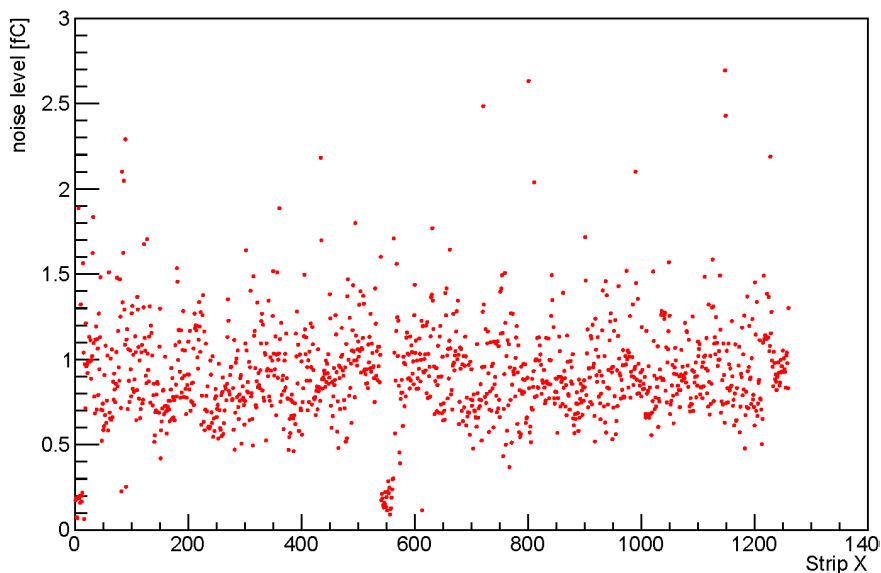
Event Cluster charge



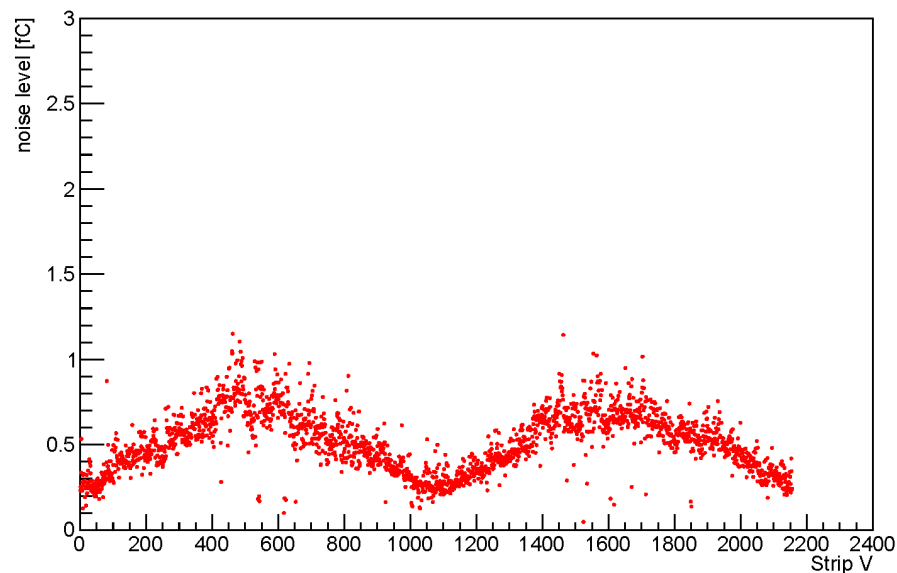
**Charge Centroid
spatial resolution**

Noise measurements on CGEM

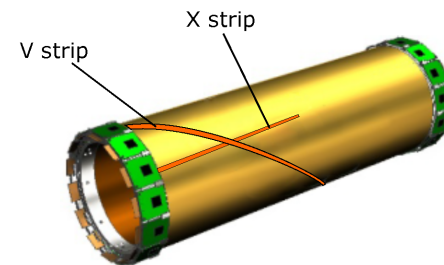
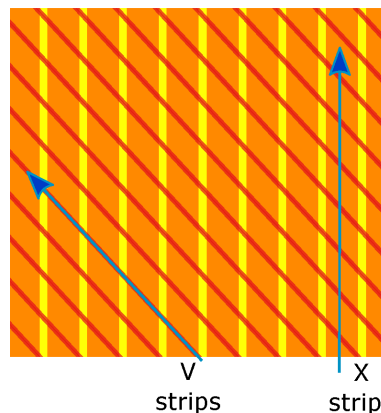
Noise Layer 2 (strip X)



Noise Layer 2 (strip V)



- Almost flat distribution for **X-strips**
- **V-strips** noise follows the strips length

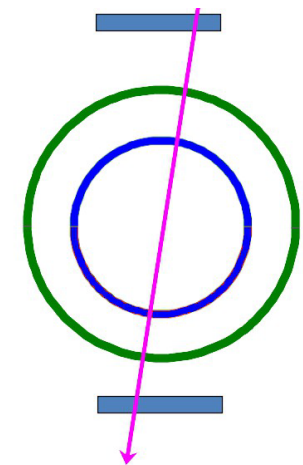
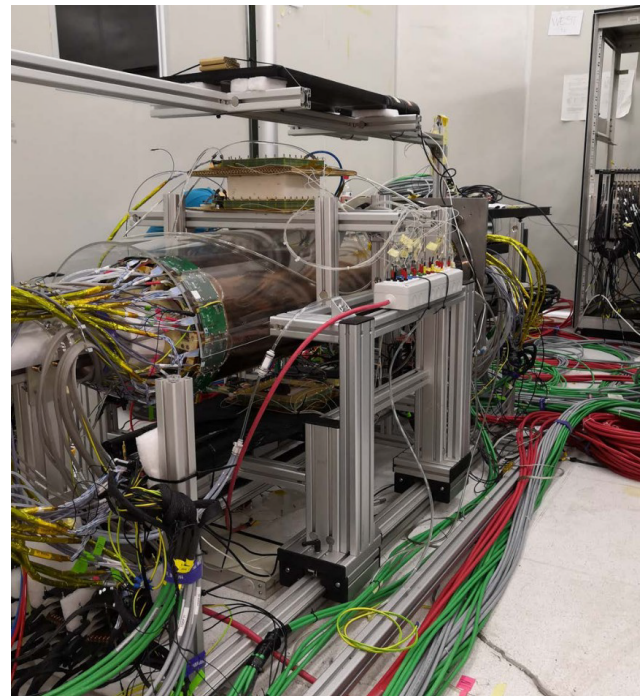


CGEM-IT commissioning and tests



Two out of three layers of the CGEM-IT detector are assembled together and cosmic rays acquisitions are now ongoing at IHEP (Beijing, China)

- 88 TIGER ASICs readout by 11 GEMROC modules (>5000 electronics channels instrumented)
- GUF (Graphical User Front-end Interface) software provides DAQ control tools for:
 - Trigger-matched cosmic acquisition
 - Trigger-less operation for periodic maintenance



Cosmic ray
Scintillating bar
Layer 1
Layer 2

R. Farinelli, "Preliminary results from the cosmic data taking of the BESIII cylindrical GEM detectors", talk at INSTR-20, Novosibirsk, Russia

Thanks for your attention.

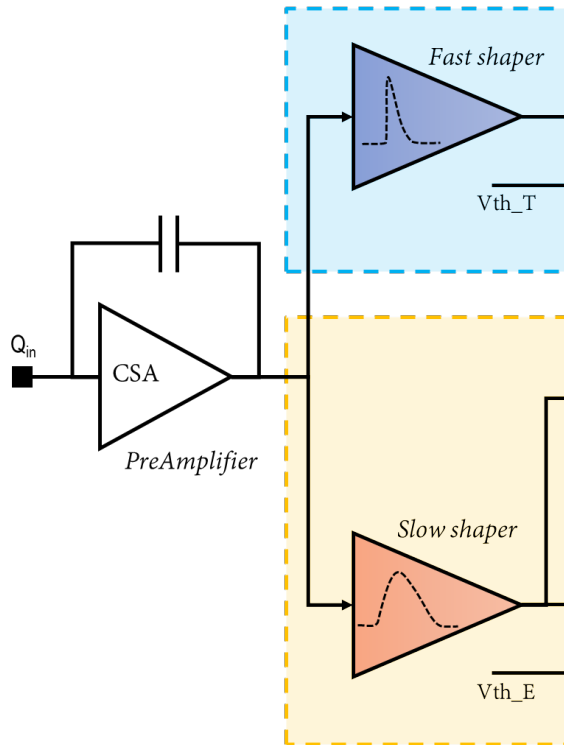


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1. CSA pre-amplifier

- $Q_{in} = 2 - 50 \text{ fC}$
- input transistor bias current set by 6-bit DAC (1.5 – 4.5 mA)
- ENC target $< 2000 \text{ e}^- @ C_{in} = 100 \text{ pF}$

2. Time-branch

- Simple CR-RC shaper
- 60 ns peaking time for low-jitter timing measurement

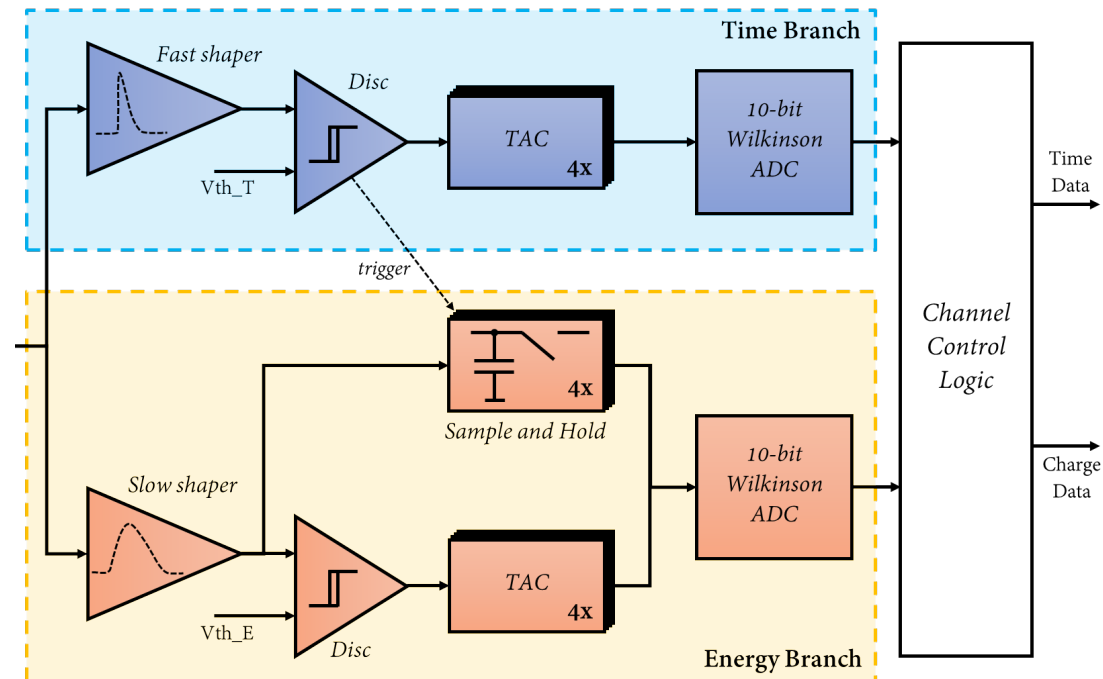
3. Energy-branch

- 4 complex-conjugate poles shaper for a more gaussian signal shape to reduce pile-up probability
- 170 ns peaking time for signal-to-noise ratio optimization
- **BLH** to lock the shapers output DC to an external reference value ($V_{BL} = 350 \text{ mV}$)

➤ Total gain $\approx 12 \text{ mV/fC}$

Triggerless Readout

- **LE discriminators** with 6-bit DAC programmable thresholds and 3-bit DAC hysteresis
- **Data-push** readout architecture: each signal above the selected threshold is taken as a good event, digitized and sent off-chip (no external trigger)



Time and Charge Measurement

- Coarse time measurement from the chip master clock counter
- Fine time measurement with low-power analogue TDCs based on time interpolation (I.F. = 128)
 - 50 ps time binning @ 160 MHz
 - Quad-buffered TACs for event de-randomization
 - TAC buffers with refresh scheme to avoid off-chip correction algorithm for leakage
- Charge measurement with S/H circuit sampling the E-branch shaper output
 - Programmable sampling time targeting the signal peak
 - Digitization with Wilkinson ADC shared with the TDC
 - Quad-buffered sampling capacitors for event de-randomization
- Charge measurement from ToT information by operating both branches in TDC mode (backup solution)

